

### 深圳市长江微电科技有限公司

### SZ CJIANG TECHNOLOGY CO.,LTD

#### 1. Scope



### inductor.2. Product Description and Identification (Part Number)



FNRH201610S series of Wire wound SMD power inductor.

### 2) Product Identification (Part Number)

<u>FNRH</u>	201610	<u>S</u>	-	<u>2R2</u>	M	<u>T</u>
1	2	3		4	(5)	6

1)		Туре	
FNRH	Ferrite	Inductor	

3	Feature type
S	Standard Product

(5)	Inductance Tolerance
N	$\pm 30\%$
M	±20%

6	Packing
Т	Tape Carrier Package



RoHS

② Externa	② External Dimensions(L×W×H)					
201610	2.0×1.6×1.0					

4 Nominal Inductance						
Example	Example					
1R0	1.0uH					
100	10uH					
101	100uH					

### 3. Electrical Characteristics

Please refer to Item 5.

- 1) Operating temperature range (individual chip without packing): -40 $^{\circ}$ C ~ +125 $^{\circ}$ C (Including Self-heating).
- 2) Storage temperature range (packaging conditions): -10°C ~ +40°C and RH 70% (Max.).

#### 4. Shape and Dimensions (Unit:mm)

Dimensions and recommended PCB pattern for reflow soldering, please see fig4-1 and Table4-1

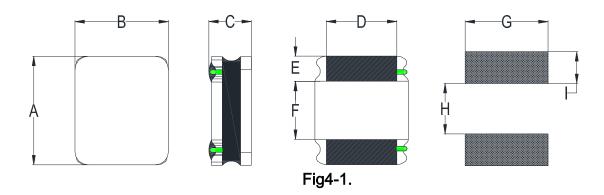


Table 4-1.

Α	В	С	D	Е	F	G	Η	
2.0 ± 0.2	1.6± 0.2	1.05Max	1.2±0.2	0.60±0.2	0.8 ± 0.2	1.6Ref	0.70 Ref	0.70 Ref



### 深圳市长江微电科技有限公司

### SZ CJIANG TECHNOLOGY CO.,LTD

#### 5. Electrical Characteristics

	Inductance	ductance Tolerance		DCR(mΩ)		Isat (A)		e(A)	Test
Part Number	(uH)	(±%)	Max	Тур	Max	Тур	Max	Тур	Condition
FNRH201610S-R24MT	0.24	20	40	33	3.70	4.10	2.80	3.10	1MHz /1.0V
FNRH201610S-R33MT	0.33	20	48	41	3.00	3.70	2.40	2.90	1MHz /1.0V
FNRH201610S-R47MT	0.47	20	60	50	2.30	2.85	2.30	2.60	1MHz /1.0V
FNRH201610S-R56MT	0.56	20	68	53	2.20	2.80	2.00	2.20	1MHz /1.0V
FNRH201610S-R68MT	0.68	20	76	63	1.95	2.45	2.00	2.20	1MHz /1.0V
FNRH201610S-1R0MT	1.0	20	114	96	1.65	1.85	1.45	1.60	1MHz /1.0V
FNRH201610S-1R5MT	1.5	20	174	145	1.35	1.65	1.10	1.20	1MHz /1.0V
FNRH201610S-2R2MT	2.2	20	265	215	1.20	1.45	1.05	1.15	1MHz /1.0V
FNRH201610S-3R3MT	3.3	20	345	290	1.00	1.20	0.85	0.95	1MHz /1.0V
FNRH201610S-4R7MT	4.7	20	480	400	0.75	0.90	0.70	0.80	1MHz /1.0V
FNRH201610S-5R6MT	5.6	20	672	560	0.73	0.88	0.60	0.70	1MHz /1.0V
FNRH201610S-6R8MT	6.8	20	800	610	0.70	0.85	0.55	0.60	1MHz /1.0V
FNRH201610S-8R2MT	8.2	20	940	730	0.68	0.78	0.53	0.60	1MHz /1.0V
FNRH201610S-100MT	10	20	1000	800	0.65	0.70	0.50	0.60	1MHz /1.0V
FNRH201610S-120MT	12	20	1430	1100	0.62	0.70	0.36	0.42	1MHz /1.0V
FNRH201610S-150MT	15	20	1700	1300	0.50	0.56	0.30	0.38	1MHz /1.0V
FNRH201610S-220MT	22	20	1700	1400	0.32	0.38	0.30	0.36	1MHz /1.0V

Note: 1: Rated current: Isat(max.) or Irise(max.), whichever is smaller;

\*2: Saturation Current: Max. Value, DC current at which the inductance drops less than 30% from its value without current; Typ. Value, DC current at which the inductance drops 30% from its value without current;

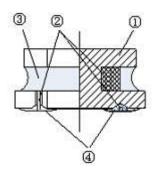
3: Irise: DC current that causes the temperature rise ( $\Delta T$ ) from 20°C ambient.

For Max. Value,  $\triangle T < 40^{\circ}C$ ; for Typ. Value,  $\triangle T$  is approximate  $40^{\circ}C$ .

The part temperature (ambient + temp. rise) should not exceed  $125^{\circ}$ C under worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

#### 6. Structure

The structure of FNRH201610S product.



NO.	Components	Material
1	Core	Ni-Zn Ferrite
2	Wire	Polyurethane system enameled copper wire
3	Magnetic Glue	Epoxy resin and magnetic powder
4	Electrodes	AgNiSn or FeNiCu + Sn Alloy



# 深圳市长江微电科技有限公司 SZ CJIANG TECHNOLOGY CO.,LTD

## 7. Reliability Test

Items	Requirements	Test Methods and Remarks
7.1 Terminal Strength	No removal or split of the termination or other defects shall occur.	Solder the inductor to the testing jig (glass epoxy board shown in Fing.7.1-1) using eutectic solder. Then apply a force in the direction of the arrow.     10N force.     Sheep time: 5±2s
7.2 High Temperature	No visible mechanical damage.     Inductance change: Within ±10%	<ol> <li>Storage Temperature :125+/-5℃</li> <li>Duration : 96 ±4 Hours</li> <li>Recovery : then measured at room ambient temperature after placing 24 hours.</li> </ol>
7.3 Low Temperature	No visible mechanical damage     Inductance change: Within ±10%	1) Temperature and time: -40±5°C  2) Duration: 96 <sup>±</sup> 4 hours  3) TRecovery: then measured at room ambient temperature after placing 24 hours.
7.4 Vibration test	No visible mechanical damage.     Inductance change: Within ±10%	1) Frequency range:10HZ~55HZ~10HZ 2) Amplitude:1.5mm p-p 3) Direction:X,Y,Z 4) Time:1 minute/cycle,2hours per axis
7.5 High Temperature Storage Tested	No visible mechanical damage.     Inductance change: Within ±10%	<ol> <li>Storage Temperature :60+/-2℃</li> <li>Relative Humidity :90-95% RH</li> <li>Duration : 96 ±4 Hours</li> <li>Recovery : then measured at room ambient temperature after placing 24 hours.</li> </ol>
7.6 Resistance to Soldering Heat	1. No visible mechanical damage. 2. Inductance change: Within ±10%  260°C  Peak 260°C max  Max Ramp Up Rate=3°C/sec  Max Ramp Down Rate=6°C/sec  150°C  Time 25°C to Peak =8 min max  Fig.7.6-1	1) Re-flowing Profile: Please refer to Fig.7.6-1 2) Test board thickness: 1.0mm 3) Test board material: glass epoxy resin 4) The chip shall be stabilized at normal condition for 1~2 hours before measuring
7.7 Thermal Shock	1. No visible mechanical damage.  2. Inductance change: Within ±10%  105°C 30 min.  Ambient Temperature  40°C  Max 3 minute  Fig.7.7-1	<ol> <li>Temperature and time: -40±3°C for 30±3 min→105°C for 30±3min, please refer to Fig.7.7-1.</li> <li>Transforming interval: Max, 3 minute</li> <li>Tested cycle: 100 cycles</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring</li> </ol>

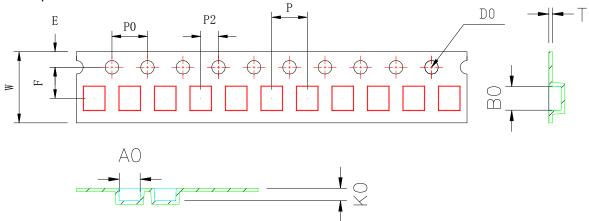


# 深圳市长江微电科技有限公司

# SZ CJIANG TECHNOLOGY CO.,LTD

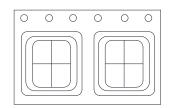
# 8. Packaging and Marking:

### 8-1. Carrier Tape Dimensions:



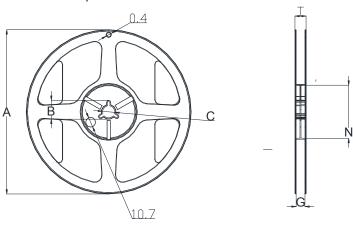
ITEM	w	A0	В0	K0	Р	F	Е	D0	P0	P2	Т
DIM	8.00	2.00	2.40	1.20	4.00	3.5	1.75	1.50	4.00	2.00	0.25
TOLE	±0.3	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	+0.1	±0.1	±0.1	±0.05

### 8-2. Taping Dimensions:



### 8-3. Reel Dimensions:

Carrier Tape Reel



Туре	А	В	С	G	N	Т
8mm	178	20.7±0.8	13±0.4	9	60	10.8

### 8-4. Packaging Quantity:

2KPCS/ Reel 20KPCS/ Inner Box 8

80KPCS/ Outer Box

编带时,卷带前后各留空 20cm 最小

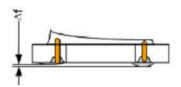


# 深圳市长江微电科技有限公司 SZ CJIANG TECHNOLOGY CO.,LTD

# 9. Visual Inspection Standard of Product

Visual Inspection Standard of Product

No.	Defect Item	Figure	Rejection Identification	Acceptance
1	Core Defect		The defect length(c or f)more than L/6 or W/6 , NG	AQL=0.65
2	Core Crack		Visual cracks , NG	AQL=0.65
3	Starvation		(1)Resin starved length a more than L/2, NG (2)When L>2mm,b>H/2, NG (3)When L≦2mm, b don't control	AQL=0.65
4	Excessive glue		The length, width or height of product beyond specified value, NG	AQL=0.65
5	Cold Solder		(1)For CR2520** Series , cold solder N>0.5mm,NG (2)For other series, cold solder N>1mm,NG	AQL=0.65
6	Marking Defect		The marking angle a>45° , NG	AQL=0.65



Af: Clearance between terminal and the surface of plate must be 0.1mm max when coil is placed on a flat plate.